



Final Product Change Notification

202306004F01 : Dual Sourcing TEA19161 to Vanguard

Note: This notice is NXP Company Proprietary.

Issue Date: Jun 11, 2023 **Effective date:** Sep 09, 2023

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Management summary

Dual sourcing HV die TEA19161 to Vanguard (VIS) to create more sourcing flexibility and capacity expansion (next to HV die ICN8).

Change Category

☐ Wafer Fab Process	☐ Assembly Process	☐ Product Marking	☐ Test Process	☐ Design
☐ Wafer Fab Materials	☐ Assembly Materials	☐ Mechanical Specification	☐ Test Equipment	☐ Errata
☒ Wafer Fab Location	☐ Assembly Location	☐ Packing/Shipping/Labeling	☐ Test Location	☐ Electrical spec./Test coverage
☐ Firmware ☐ Other				

PCN Overview

Description

Dual sourcing HV die TEA19161 to Vanguard (also in ICN8).

Reason

Create more sourcing flexibility and capacity expansion.

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment Sep 07, 2023

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Products will be delivered from both waferfabs.

Additional information

Self qualification: [view online](#)

Additional documents: [view online](#)

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Jul 11, 2023.

Remarks

n.a.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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Orderable Part Number#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	Product Line
TEA19161T/2Y	935308799518	TEA19161T/2	resonant LLC power supply	SO16	SOT109-1	RFS	No	BLC4
TEA19161CT/1Y	935307964518	TEA19161CT/1	resonant LLC power supply	SO16	SOT109-1	RFS	No	BLC4